



*Testing Tomorrow's Technology*

**INTERNAL PHOTO LETTER**

Date: October 31, 2018

Subject: INTERNAL PHOTOGRAPHS FOR: Inventek Systems ISM4343-X Module,  
FCC ID: O7P-4343 and IC: 10147A-4343

Inventek Systems does not have and cannot provide internal photos of the ISM4343-X Modules, as the modules are manufactured using a SIP (System in Package) process. This process results in the final modules being encapsulated in the packaging material during the time of manufacture. Based on this, they are unable to provide pictures of the module without the cover.

Sincerely,

By:

*Sandi McEnergy*  
(Signature/Title)

Sandi McEnergy - Agent  
(Print name)

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